

Project Number: Design Qualification Test Report   Tracking Code: 187547_Report_Rev_1							
Requested by: Mark Shireman Date: 4/20/2012 Product Rev: N/A							
Part #: SQT-125-01-L-D\TMMH-125-01-L-DV					Eng: Eric Mings		
Part description: SQT/TMMH Qty to test: 16					test: 16		
Test Start: 03/13/2012	Test Completed: 04/	06/2012					

# DESIGN QUALIFICATION TEST REPORT

 $SQT\ TMMH$   $SQT-125-01-L-D\ TMMH-125-01-L-DV\ (10u''\ Gold)$   $SQT-125-01-S-D\ TMMH-125-01-S-DV\ (30u''\ Gold)$ 

Tracking Code: 187547_Report_Rev_1	Part #: SQT-125-01-L-D\TMMH-125-01-L-DV
	SQT-125-01-S-D\TMMH-125-01-S-DV
Part description	n: SQT/TMMH

### **CERTIFICATION**

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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### **SCOPE**

To perform the following tests: Design Qualification test. Please see test plan.

### APPLICABLE DOCUMENTS

Standards: EIA Publication 364

### TEST SAMPLES AND PREPARATION

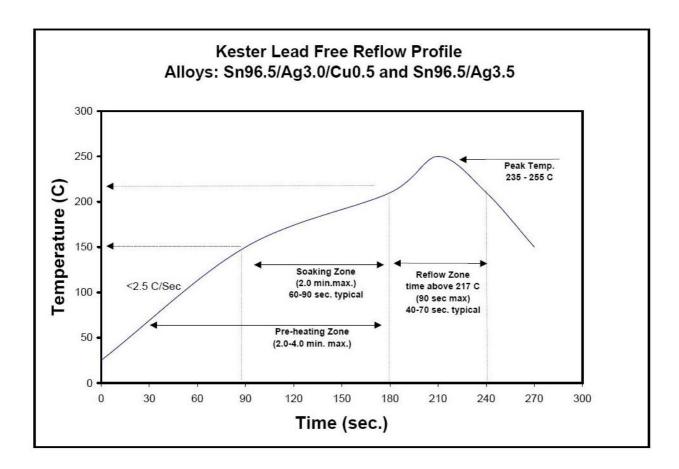
- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free
- 9) Re-Flow Time/Temp: See accompanying profile.

Part #: SQT-125-01-L-D\TMMH-125-01-L-DV SQT-125-01-S-D\TMMH-125-01-S-DV

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# **TYPICAL OVEN PROFILE (Soldering Parts to Test Boards)**

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SOT-125-01-S-D\TMMH-125-01-S-DV

Part description: SQT/TMMH

# **FLOWCHARTS**

# LLCR/Durability

TEST	GROUP A1	GROUP B1
STEP	10u" Gold (-L)	30u" Gold (-S)
	8 Mated Sets	8 Mated Sets
01	LLCR-1	LLCR-1
02	100 Cycles	100 Cycles
03	LLCR-2	LLCR-2
04	Thermal Shock (Mated and Undisturbed)	Thermal Shock (Mated and Undisturbed)
04 05		
	(Mated and Undisturbed)	(Mated and Undisturbed)

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Thermal Shock = EIA-364-32, Table II, Test Condition I:

-55°C to +85°C 1/2 hour dwell, 100 cycles

Humidity = EIA-364-31, Test Condition B (240 Hours)

and Method III (+25°C to +65°C @ 90% RH to 98% RH)

ambient pre-condition and delete steps 7a and 7b

LLCR = EIA-364-23, LLCR

20 mV Max, 100 mA Max

Use Keithley 580 or 3706 in 4 wire dry circuit mode

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### ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

# THERMAL SHOCK:

- 1) EIA-364-32, Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors.
- 2) Test Condition 1:  $-55^{\circ}$ C to  $+85^{\circ}$ C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

#### **HUMIDITY:**

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors*.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to +65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

#### LLCR:

- 1) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
  - a. <= +5.0 mOhms: ------ Stable b. +5.1 to +10.0 mOhms: ----- Minor c. +10.1 to +15.0 mOhms: ---- Acceptable d. +15.1 to +50.0 mOhms: ---- Marginal e. +50.1 to +2000 mOhms: ---- Unstable

Part #: SQT-125-01-L-D\TMMH-125-01-L-DV SQT-125-01-S-D\TMMH-125-01-S-DV

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Humidity

### RESULTS **LLCR Durability** SQT-125-01-L-D\TMMH-125-01-L-DV (10u" Gold) 192 LLCR test points Initial ------6.47mOhms Max **Durability 100 cycles** <= +5.0 mOhms ----- Stable +5.1 to +10.0 mOhms ----- Minor +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------ Open Failure 0 **Thermal** <= +5.0 mOhms ----- Stable 0 +5.1 to +10.0 mOhms ----- Minor 0 +10.1 to +15.0 mOhms ------ Acceptable 0 +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------ Open Failure 0 Humidity <= +5.0 mOhms ----- Stable 0 +5.1 to +10.0 mOhms------ Minor 0 +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------ Open Failure SOT-125-01-S-D\TMMH-125-01-S-DV (30u" Gold) 192 LLCR test points Initial ------6.35mOhms Max **Durability 100 cycles** <= +5.0 mOhms ----- Stable +5.1 to +10.0 mOhms------ Minor +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------ Open Failure **Thermal** <= +5.0 mOhms ----- Stable +5.1 to +10.0 mOhms------ Minor 0 +10.1 to +15.0 mOhms ------ Acceptable +15.1 to +50.0 mOhms ------ Marginal +50.1 to +2000 mOhms------ Unstable >+2000 mOhms------ Open Failure

<= +5.0 mOhms ------ 192 Points ----- Stable +5.1 to +10.0 mOhms ----- 0 Points ----- Minor +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal +50.1 to +2000 mOhms ----- 0 Points ----- Unstable >+2000 mOhms ----- 0 Points ----- Open Failure 
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Part description: SQT/TMMH

## **DATA SUMMARIES**

# LLCR Durability: SQT-125-01-L-D\TMMH-125-01-L-DV (10u" Gold)

- 1) A total of 192 points were measured.
- 2) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.

a.	<= +5.0 mOhms:	Stable
b.	+5.1 to +10.0 mOhms:	Minor
c.	+10.1 to +15.0 mOhms:	Acceptable
d.	+15.1 to +50.0 mOhms:	Marginal
e.	+50.1 to +2000 mOhms	Unstable
f.	>+2000 mOhms:	Open Failure

	LLCR Measurement Summaries by Pin Type						
Date	2012-3-13 2012-3-14 2012-3-26 2012-4-6						
Room Temp (Deg							
C)	22	22	22	22			
Rel Humidity (%)	40	37	38	32			
Technician	Troy Cook	Troy Cook	Troy Cook	Troy Cook			
mOhm values	Actual	Actual Delta		Delta			
	Initial	100 Cycles	Thermal	Humidity			
	Initial	100 Cycles Pin Type		Humidity			
Average	Initial 5.22			Humidity 0.31			
Average St. Dev.		Pin Type '	1: Signal	j			
	5.22	<b>Pin Type</b> 20.23	1: <b>Signal</b> 0.28	0.31			
St. Dev.	5.22 0.36	Pin Type 7 0.23 0.24	0.28 0.26	0.31 0.27			
St. Dev. Min	5.22 0.36 4.57	Pin Type 2 0.23 0.24 0.00	0.28 0.26 0.00	0.31 0.27 0.00			

LLCR Delta Count by Category							
Stable Minor Acceptable Marginal Unstable Open							
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000	
100 Cycles	192	0	0	0	0	0	
Thermal	192	0	0	0	0	0	
Humidity	192	0	0	0	0	0	

Part description: SQT/TMMH

## **DATA SUMMARIES Continued**

## LLCR Durability: SQT-125-01-S-D\TMMH-125-01-S-DV (30u" Gold)

- 1) A total of 192 points were measured.
- 2) EIA-364-23, Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
  - a. <= +5.0 mOhms: ------ Stable
    b. +5.1 to +10.0 mOhms: ----- Minor
    c. +10.1 to +15.0 mOhms: ----- Acceptable
    d. +15.1 to +50.0 mOhms: ---- Marginal
    e. +50.1 to +2000 mOhms: ---- Unstable
    f. >+2000 mOhms: ---- Open Failure

	LLCR Measurement Summaries by Pin Type						
Date	2012-3-13 2012-3-14 2012-3-26 20 <sup>-1</sup>						
Room Temp (Deg							
C)	23	22	22	22			
Rel Humidity (%)	38	36	38	32			
Technician	Troy Cook	Troy Cook	Troy Cook	Troy Cook			
mOhm values	Actual Delta		Delta	Delta			
	Initial	100 Cycles	Thermal	Humidity			
		Pin Type '	1: Signal				
Average	- 00						
Average	5.32	0.39	0.46	0.58			
St. Dev.	0.36	0.39 0.28	0.46 0.36	0.58 0.33			
St. Dev.	0.36	0.28	0.36	0.33			
St. Dev. Min	0.36 4.66	0.28	0.36 0.00	0.33 0.02			

LLCR Delta Count by Category							
Stable Minor Acceptable Marginal Unstable Oper							
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000	
100 Cycles	192	0	0	0	0	0	
Thermal	192	0	0	0	0	0	
Humidity	192	0	0	0	0	0	

Part description: SQT/TMMH

# EQUIPMENT AND CALIBRATION SCHEDULES

**Equipment #:** MO-04

**Description:** Multimeter /Data Acquisition System

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Manufacturer: Keithley

Model: 2700 Serial #: 0798688 Accuracy: See Manual

... Last Cal: 04/30/2011, Next Cal: 04/30/2012

**Equipment #:** THC-02

**Description:** Temperature/Humidity Chamber

Manufacturer: Thermotron

Model: SE-1000-6-6 Serial #: 31808 Accuracy: See Manual

... Last Cal: 02/16/2012, Next Cal: 02/16/2013

**Equipment #:** TSC-01

**Description:** Vertical Thermal Shock Chamber

Manufacturer: Cincinnatti Sub Zero

Model: VTS-3-6-6-SC/AC Serial #: 10-VT14993 Accuracy: See Manual

... Last Cal: 05/18/2011, Next Cal: 05/18/2012